GN01064B

GaAs IC (with built-in ferroelectric)

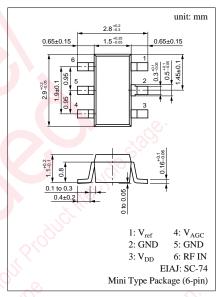
Variable gain amplifier for a cellular phone

■ Features

- Low distortion characteristics
- Low consumption current
- Small package: Mini 6pin

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit	
Power supply voltage	V _{DD}	5	V	
Gate control voltage	V _{AGC}	0 to 3	V	
Circuit current	I _{DD}	40	mA	
Max input power	P _{in}	0	dBm	
Allowable power dissipation	P_{D}	200	mW	
Operating ambient temperature	T_{opr}	-30 to +90	°C	
Storage temperature	T _{stg}	-40 to +120	°C	



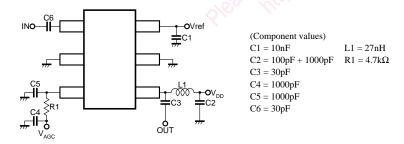
Marking Symbol: IR

■ Electrical Characteristics (V_{DD}, V_{ref} = 3.0V, f = 940MHz, Ta = 25 ± 3°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Circuit current	I_{DD}^{*1}	$V_{AGC} = 2V$, $P_{in} = -15$ dBm	In "I	9	12	mA
Power gain 1	PG ₁ *1	$V_{AGC} = 2V, P_{in} = -15dBm$	10	13	0.	dB
Power gain 2	PG ₂ *1	$V_{AGC} = 1V$, $P_{in} = -15$ dBm	-29	-22	18	dB
	, ci	$V_{AGC} = 1$ to 2V, $P_{in} = \le -7$ dBm	.0.	1000		
Modulation distortion	DM*1, 2	$P_{out} = \leq 0dB$	The "	-65	-60	dBc
	$O_{I_{\alpha}}$	±50kHz Detuning, 21kHz Bandwidth	$O_{0,1}$			

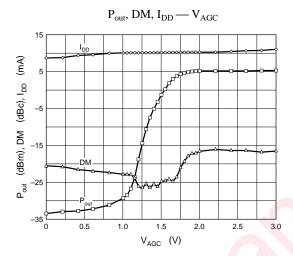
^{*1} Measurement circuit is shown in the following diagram.

■ Measurement Circuit



^{*2} Design-guaranteed items.

GaAs MMICs GN01064B





■ This product contains Gallium Arsenide (GaAs).

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